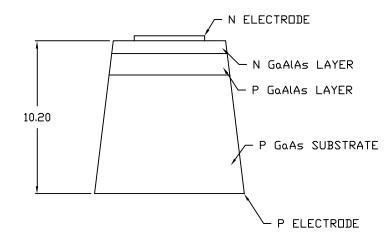
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10.00 SQR. 7.50 SQR. Ø4.70 -



PART NUMBER

REV.

SSD-LX010F660SGNU

ELECTRO-OPTICAL CHARACTERISTICS:

PARAMETER	SYMBOL	TEST COND	MIN	TYP	MAX	UNITS
FORWARD VOLTAGE	۷f	I _f =20mA		1.85	2.0	٧
REVERSE CURRENT	۱r	V _r =5V			10	μA
PEAK WAVELENGTH	λp	I _f =20mA		660		nm
SPECTRA HALF-WIDTH	Δλ	I _f =20mA		20		nm
LUMINOUS INTENSITY	١ _٧	I _f =20mA	6			mcd

CAUTION: STATIC SENSITIVE DEVICE FOLLOW PROPER E.S.D. HANDLING PROCEDURES WHEN WORKING WITH THIS PART.

NOTEs:

- 1. UNITS: mil
- 2. WIRE BOND METALLIZATION: GOLD.

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REV.

PART NUMBER SSD-LX010E660SGNU

660nm AlGaAs CHIP, GOLD BOND PAD, N-SIDE UP.

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OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.



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DRAWN BY:

CHECKED BY: APPROVED BY: DATE: 10.15.03 PAGE: 1 OF 1

SCALE: N/A

CT